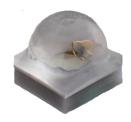
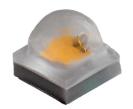
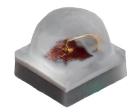
# CREE 💠

# Cree® XLamp® XQ-A LEDs









### **PRODUCT DESCRIPTION**

The XLamp® XQ-A LED brings a mid-power, cost-effective option to the proven, compact ceramic XQ package, enabling lighting manufacturers to quickly and easily expand their product portfolio by leveraging a common XQ design. Unlike plastic mid-power LEDs, the ceramic-based XQ-A LEDs are designed to deliver the long-term calculated lifetimes of Cree's other high-power LEDs. The XQ-A LED's combination of optical symmetry and consistency across all colors improves color mixing and simplifies the production process for lighting manufacturers. Available in both white and color configurations, the XQ-A LED family opens up new design possibilities for a wide spectrum of lighting applications, such as portable, directional and architectural lighting.

### **FEATURES**

- Cree's smallest lighting class LED:
   1.6 X 1.6 mm
- Available in 70-, 80- & 90-CRI white, and royal blue, blue, PC blue, green, PC amber, red-orange & red
- Maximum drive current: white: 300 mA, color: 250 mA
- Wide viewing angle: white: 100°, royal blue, blue, PC blue, PC amber: 105°, green, red-orange, red: 110°
- Reflow solderable JEDEC
   J-STD-020C compatible
- Unlimited floor life at
   ≤ 30 °C/85% RH
- · RoHS compliant
- UL® recognized component (E349212)

### **TABLE OF CONTENTS**

Characteristics2
Flux Characteristics - White3
Flux Characteristics - Color4
Relative Spectral Power Distribution6
Relative Flux vs. Junction Temperature.7
Electrical Characteristics8
Relative Flux vs. Current9
Relative Chromaticity vs. Current and
Temperature11
Typical Spatial Distribution12
Thermal Design13
Reflow Soldering Characteristics14
Notes15
Mechanical Dimensions16
Tape and Reel17
Packaging18





### **CHARACTERISTICS**

Characteristics	Unit	Minimum	Typical	Maximum
Thermal resistance, junction to solder point - white	°C/W		20	
Thermal resistance, junction to solder point - royal blue, blue, PC blue	°C/W		17	
Thermal resistance, junction to solder point - green	°C/W		30	
Thermal resistance, junction to solder point - PC amber	°C/W		20	
Thermal resistance, junction to solder point - red-orange, red	°C/W		18	
Viewing angle (FWHM) - white	degrees		100	
Viewing angle (FWHM) - royal blue, blue, PC blue, PC amber	degrees		105	
Viewing angle (FWHM) - green, red-orange, red	degrees		110	
Temperature coefficient of voltage - white	mV/°C		-2.8	
Temperature coefficient of voltage - royal blue, blue, PC blue	mV/°C		-4	
Temperature coefficient of voltage - green	mV/°C		-4.3	
Temperature coefficient of voltage - PC amber	mV/°C		-4.2	
Temperature coefficient of voltage - red-orange, red	mV/°C		-2.0	
ESD withstand voltage (HBM per Mil-Std-883D) - white, royal blue, blue, PC blue, green, red-orange, red			Class 3A	
ESD classification (HBM per Mil-Std-883D) - PC amber			Class 2	
DC forward current-white	mA			300
DC forward current - color	mA			250
Reverse voltage	V			5
Forward voltage (@ 175 mA, 85 °C) - white	V		3.0	3.3
Forward voltage (@ 175 mA, 25 °C) - royal blue, blue, PC blue	V		3.25	3.6
Forward voltage (@ 175 mA, 25 °C) - green	V		3.4	3.6
Forward voltage (@ 175 mA, 25 °C) - PC amber	V		3.4	3.7
Forward voltage (@ 175 mA, 25 °C) - red-orange, red	V		2.2	2.6
LED junction temperature	°C			150



### FLUX CHARACTERISTICS - WHITE (T, = 85 °C)

The following table provides several base order codes for XLamp XQ-A white LEDs. It is important to note that the base order codes listed here are a subset of the total available order codes for the product family. For more order codes, as well as a complete description of the order-code nomenclature, please consult the XLamp XQ Family LEDs Binning and Labeling document.

Color	ссті	Range	Minimum	Luminous Flux	@ 175 mA	Calculated Minimum Luminous Flux (lm) @ 85 °C**	Order Code	
	Minimum	Maximum	Group	Flux (lm) @ 85 °C	Flux (lm) @ 25 °C*	300 mA		
			M3	45.7	52.6	65.6	XQAAWT-00-0000-00000L3E2	
Cool White	5000 K	8300 K	N2	51.7	59.5	74.2	XQAAWT-00-0000-00000L4E2	
			N3	56.8	65.3	81.6	XQAAWT-00-0000-00000L5E2	
70-CRI			M3	45.7	52.6	65.6	XQAAWT-00-0000-00000B3E2	
Minimum	3700 K	8300 K	N2	51.7	59.5	74.2	XQAAWT-00-0000-00000B4E2	
White			N3	56.8	65.3	81.6	XQAAWT-00-0000-00000B5E2	
Neutral	3700 K	5300 K	M2	39.8	45.8	57.1	XQAAWT-00-0000-00000L2E4	
White	3700 K	3300 K	M3	45.7	52.6	65.6	XQAAWT-00-0000-00000L3E4	
Warm White	2700 K 3500 K	3500 K	K3	35.2	40.5	50.5	XQAAWT-00-0000-00000LZE7	
warm white	2700 K	3500 K	M2	39.8	45.8	57.1	XQAAWT-00-0000-00000L2E7	
80-CRI Minimum	2700 K	3500 K	K3	35.2	40.5	50.5	XQAAWT-00-0000-00000HZE7	
White	2700 K	3500 K	M2	39.8	45.8	57.1	XQAAWT-00-0000-00000H2E7	
90-CRI Minimum	2850 K	3000 K	K2	30.6	35.2	43.9	XQAAWT-00-0000-00000UYE7	
White	2030 K	3000 K	K3	35.2	40.5	50.5	XQAAWT-00-0000-00000UZE7	

#### Notes:

- Cree maintains a tolerance of ±7% on flux and power measurements, ±0.005 on chromaticity (CCx, CCy) measurements and ±2 on CRI measurements. See the Measurements section (page 15).
- Typical CRI for Cool White (5000 K 8300 K CCT) is 70.
- Typical CRI for Neutral White (3700 K 5300 K CCT) is 75.
- Typical CRI for Warm White (2600 K 3700 K CCT) is 80.
- Minimum CRI for 70-CRI Minimum White is 70.
- Minimum CRI for 80-CRI Minimum White is 80.
- Minimum CRI for 90-CRI Minimum White is 90.
- \* Flux values @ 25 °C are calculated and for reference only.
- \*\* Calculated flux values at 350 mA are for reference only.



# FLUX CHARACTERISTICS - COLOR (T<sub>1</sub> = 25 °C)

The following table provides several base order codes for XLamp XQ-A color LEDs. It is important to note that the base order codes listed here are a subset of the total available order codes for the product family. For more order codes, as well as a complete description of the order-code nomenclature, please consult the XLamp XQ Family LEDs Binning and Labeling document.

	Do	minant Wav	elength Rar	ige	Minimum Radion	nt Flux @ 175 mA		
Color	Mini	Minimum		mum	Willillium Radian	it Flux @ 175 IIIA	Calculated Minimum PPF	Order Code
	Group	DWL (nm)	Group	DWL (nm)	Group	Flux (mW)	(μ <b>mol/s</b> )*	
Dovel Plue	D26	450	DE7	165	11	210	0.80	XQAROY-00-0000-000000601
Royal Blue	Royal Blue D36 450	D57	465	12	250	0.95	XQAROY-00-0000-000000701	

Dominant Wavelength Range					Minimum Lumina	Fl 0 175 A	
Color	Minimim		Maximum		Minimum Luminous Flux @ 175 mA		Order Code
	Group	DWL (nm)	Group	DWL (nm)	Group	Flux (lm)	
Dive	DO	465	D6	405	F2	10.7	XQABLU-00-0000-000000T01
blue	Blue B3 465	B6	485	G2	13.9	XQABLU-00-0000-000000U01	

Color	Color Bin	Minimum Lumino	us Flux @ 175 mA	Order Code
Color Color I	Color Bin	Group	Flux (lm)	Order Code
PC Blue	N4B & N5B	H0	18.1	XQAAPB-00-0000-000000V01

	Dominant Wavelength Range			Minimum Lumina	Flore @ 175 A				
Color	Minir	num	Maxi	mum	Minimum Lumino	us Flux @ 175 mA	Calculated Minimum PPF	Order Code	
	Group	DWL (nm)	Group	DWL (nm)	Group	Flux (lm)	(µmol/s)*		
					K2	30.6	0.28	XQAGRN-00-0000-000000Y01	
Green	G2	520	G4	535	K3	35.2	0.32	XQAGRN-00-0000-000000Z01	
				M2	39.8	0.36	XQAGRN-00-0000-000000201		

Color	Colon Bin	Minimum Lumino	us Flux @ 175 mA	Ouder Code
Color Color	Color Bin	Group	Flux (lm)	Order Code
	Y2	J3	26.8	XQAAPA-00-0000-000000X01
PC Amber		K2	30.6	XQAAPA-00-0000-000000Y01
		K3	35.2	XQAAPA-00-0000-000000Z01

### Note

- Cree maintains a tolerance of ±7% on flux and power measurements, ±0.005 on chromaticity (CCx, CCy) measurements and a tolerance of ±2 on CRI measurements. See the Measurements section (page 15).
- \* Photosynthetic Photon Flux (PPF) values are calculated and for reference only.



# FLUX CHARACTERISTICS - COLOR ( $T_J = 25$ °C) - CONTINUED

	Dominant Wavelength Range				Minimum Lumino									
Color	Minimum		Maximum		Minimum Lumino	us Flux @ 175 MA	Order Code							
	Group	DWL (nm)	Group	DWL (nm)	Group Flux (lm)									
		610										K2	30.6	XQARDO-00-0000-000000Y01
Red-Orange	03		04	04	04	04	04	620	620	K3	35.2	XQARDO-00-0000-000000Z01		
					M2	39.8	XQARDO-00-0000-000000201							

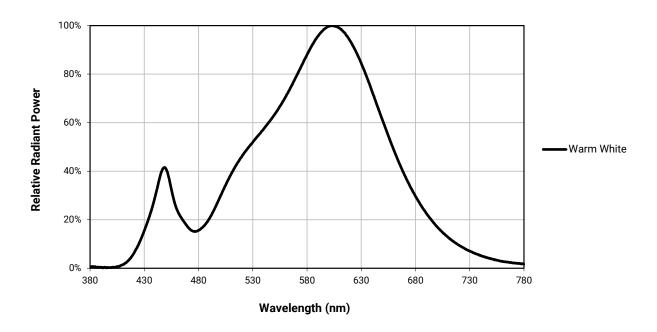
	Doi	minant Wav	elength Ran	ge	Minimum Lumina	Flore @ 175 A										
Color	Minir	num	Maxi	Minimum Luminous Flux @ 175 mA  Maximum		Calculated Minimum PPF	Order Code									
	Group	DWL (nm)	Group	DWL (nm)	Group	Flux (lm)	(µ <b>mol</b> /s)*									
			R3										J2	23.5	0.61	XQARED-00-0000-000000W01
Red	R2	620		R3 630	J3	26.8	0.70	XQARED-00-0000-000000X01								
				K2	30.6	0.80	XQARED-00-0000-000000Y01									

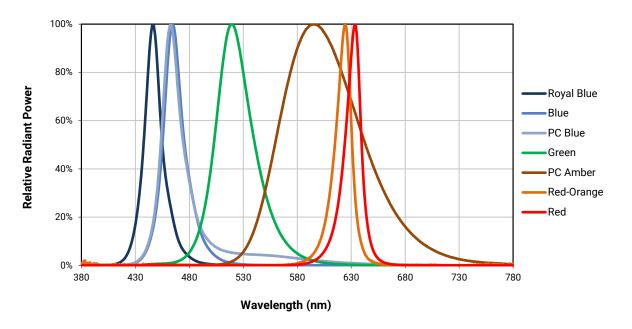
### Note

- Cree maintains a tolerance of ±7% on flux and power measurements, ±0.005 on chromaticity (CCx, CCy) measurements and a tolerance of ±2 on CRI measurements. See the Measurements section (page 15).
- \* Photosynthetic Photon Flux (PPF) values are calculated and for reference only.



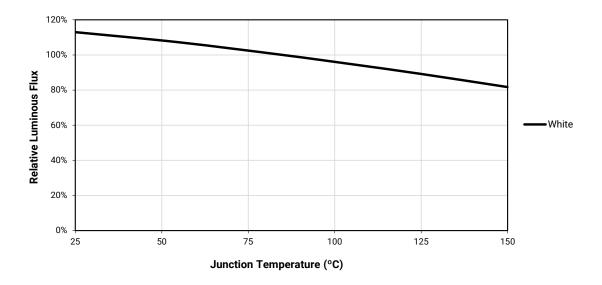
### **RELATIVE SPECTRAL POWER DISTRIBUTION**

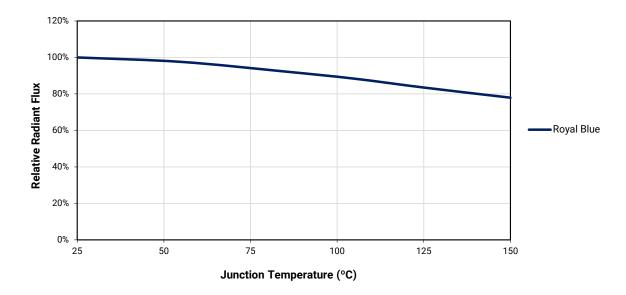






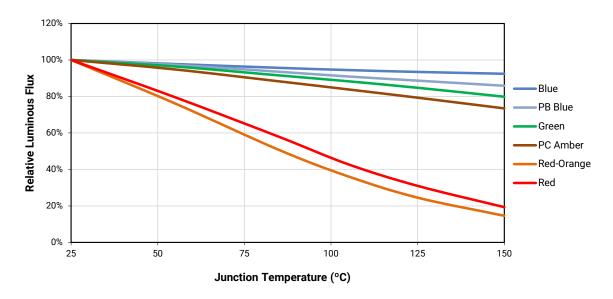
# RELATIVE FLUX VS. JUNCTION TEMPERATURE (I<sub>F</sub> = 175 mA)



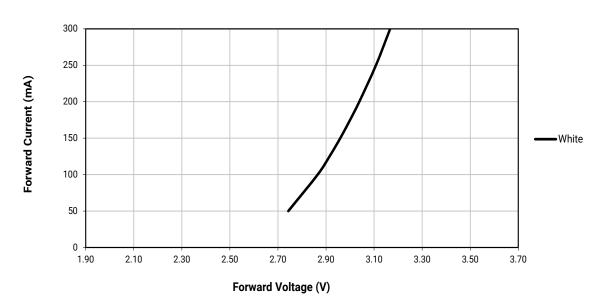


# CREE 💠

# RELATIVE FLUX VS. JUNCTION TEMPERATURE (I<sub>F</sub> = 175 mA) - CONTINUED

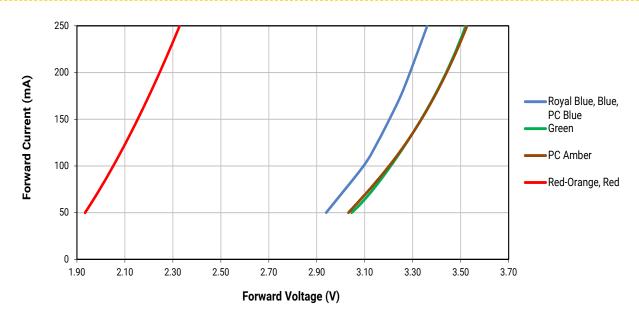


# **ELECTRICAL CHARACTERISTICS (T<sub>1</sub> = 85 °C)**

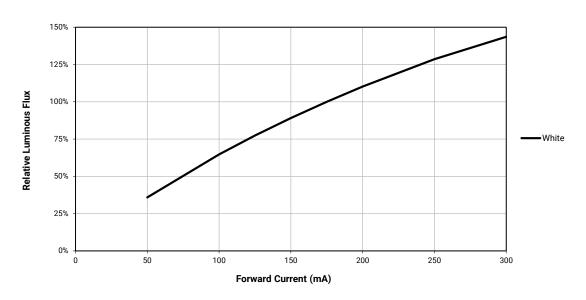




# **ELECTRICAL CHARACTERISTICS (T<sub>1</sub> = 25 °C)**

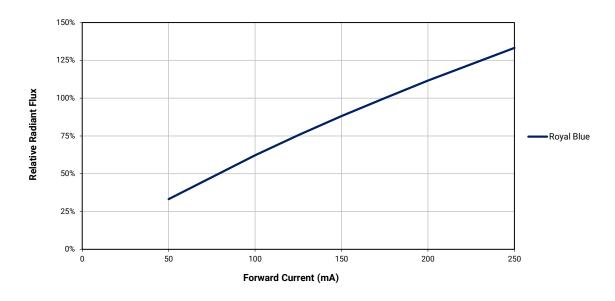


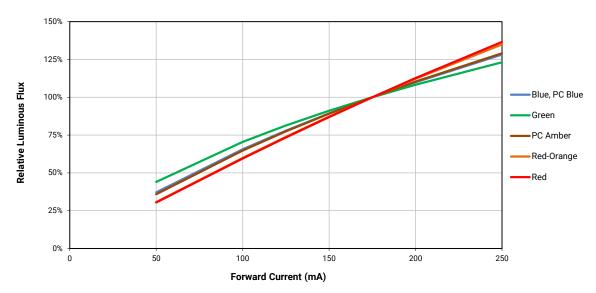
# RELATIVE FLUX VS. CURRENT (T<sub>1</sub> = 85 °C)





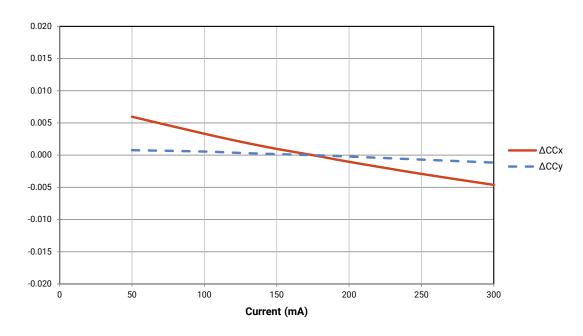
# **RELATIVE FLUX VS. CURRENT (T<sub>J</sub> = 25 °C)**

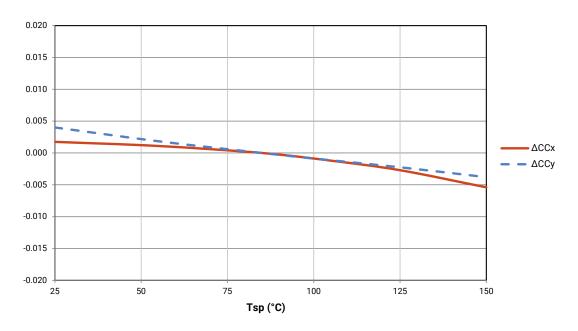






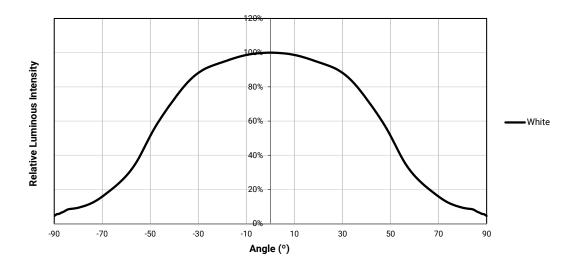
### RELATIVE CHROMATICITY VS. CURRENT AND TEMPERATURE (WARM WHITE)

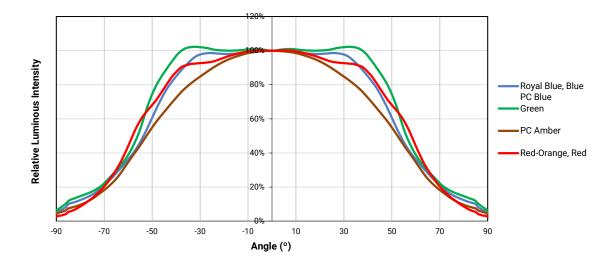






### **TYPICAL SPATIAL DISTRIBUTION**

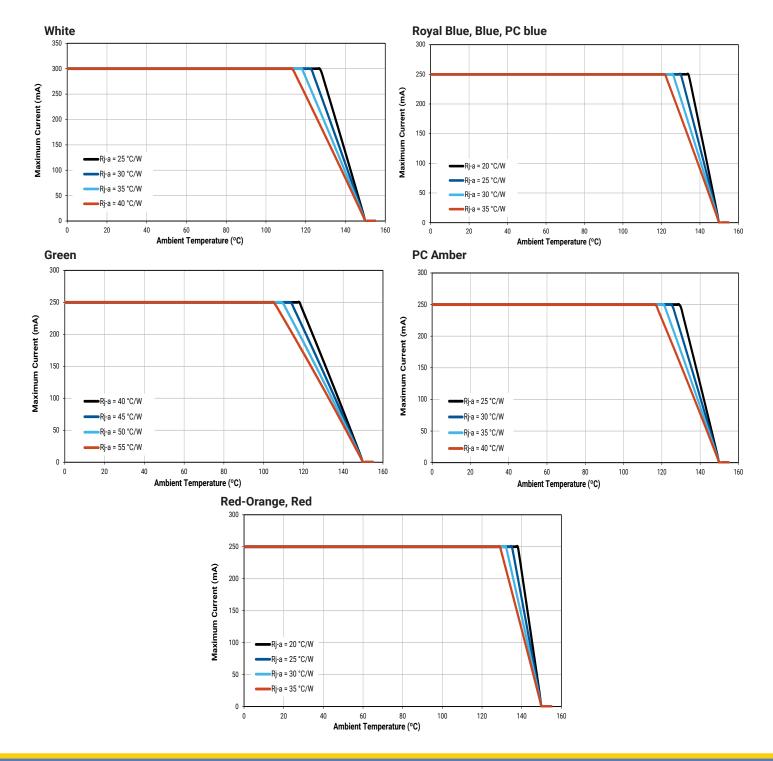






### THERMAL DESIGN

The maximum forward current is determined by the thermal resistance between the LED junction and ambient. It is crucial for the end product to be designed in a manner that minimizes the thermal resistance from the solder point to ambient in order to optimize lamp life and optical characteristics.

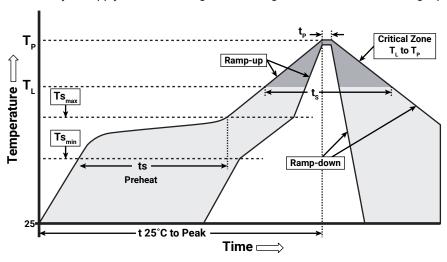




### **REFLOW SOLDERING CHARACTERISTICS**

In testing, Cree has found XLamp XQ-A LEDs to be compatible with JEDEC J-STD-020C, using the parameters listed below. As a general guideline, Cree recommends that users follow the recommended soldering profile provided by the manufacturer of the solder paste used, and therefore it is the lamp or luminaire manufacturer's responsibility to determine applicable soldering requirements.

Note that this general guideline may not apply to all PCB designs and configurations of reflow soldering equipment.



IPC/JEDEC J-STD-020C

Profile Feature	Lead-Free Solder
Average Ramp-Up Rate (Ts <sub>max</sub> to Tp)	1.2 °C/second
Preheat: Temperature Min (Ts <sub>min</sub> )	120 °C
Preheat: Temperature Max (Ts <sub>max</sub> )	170 °C
Preheat: Time (ts <sub>min</sub> to ts <sub>max</sub> )	65-150 seconds
Time Maintained Above: Temperature (T <sub>L</sub> )	217 °C
Time Maintained Above: Time (t <sub>L</sub> )	45-90 seconds
Peak/Classification Temperature (Tp)	235 - 245 °C
Time Within 5 °C of Actual Peak Temperature (tp)	20-40 seconds
Ramp-Down Rate	1 - 6 °C/second
Time 25 °C to Peak Temperature	4 minutes max.

Note: All temperatures refer to topside of the package, measured on the package body surface.



### **NOTES**

#### Measurements

The luminous flux, radiant power, chromaticity, forward voltage and CRI measurements in this document are binning specifications only and solely represent product measurements as of the date of shipment. These measurements will change over time based on a number of factors that are not within Cree's control and are not intended or provided as operational specifications for the products. Calculated values are provided for informational purposes only and are not intended or provided as specifications.

### **Pre-Release Qualification Testing**

Please read the LED Reliability Overview for details of the qualification process Cree applies to ensure long-term reliability for XLamp LEDs and details of Cree's pre-release qualification testing for XLamp LEDs.

### **Lumen Maintenance**

Cree now uses standardized IES LM-80-08 and TM-21-11 methods for collecting long-term data and extrapolating LED lumen maintenance. For information on the specific LM-80 data sets available for this LED, refer to the public LM-80 results document.

Please read the Long-Term Lumen Maintenance application note for more details on Cree's lumen maintenance testing and forecasting. Please read the Thermal Management application note for details on how thermal design, ambient temperature, and drive current affect the LED junction temperature.

### **Moisture Sensitivity**

Cree recommends keeping XLamp LEDs in the provided, resealable moisture-barrier packaging (MBP) until immediately prior to soldering. Unopened MBPs that contain XLamp LEDs do not need special storage for moisture sensitivity.

Once the MBP is opened, XLamp XQ-A LEDs may be stored as MSL 1 per JEDEC J-STD-033, meaning they have unlimited floor life in conditions of  $\leq$  30 °C/85% relative humidity (RH). Regardless of storage condition, Cree recommends sealing any unsoldered LEDs in the original MBP.

### **RoHS Compliance**

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS2), as implemented January 2, 2013. RoHS Declarations for this product can be obtained from your Cree representative or from the Product Ecology section of the Cree website.

### **UL® Recognized Component**

This product meets the requirements to be considered a UL Recognized Component with Level 1 enclosure consideration. The LED package or a portion thereof has not been investigated as a fire enclosure or a fire and electrical enclosure per ANSI/UL 8750.

### Vision Advisory

WARNING: Do not look at an exposed lamp in operation. Eye injury can result. For more information about LEDs and eye safety, please refer to the LED Eye Safety application note.

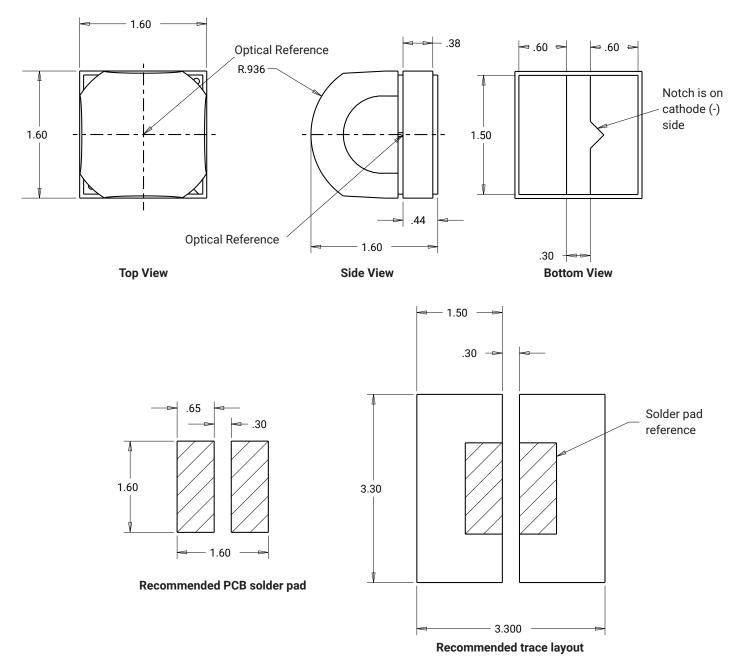


### **MECHANICAL DIMENSIONS**

Thermal vias, if present, are not shown on these drawings.

All dimensions in mm.

Measurement tolerances unless indicated otherwise: ±.13 mm



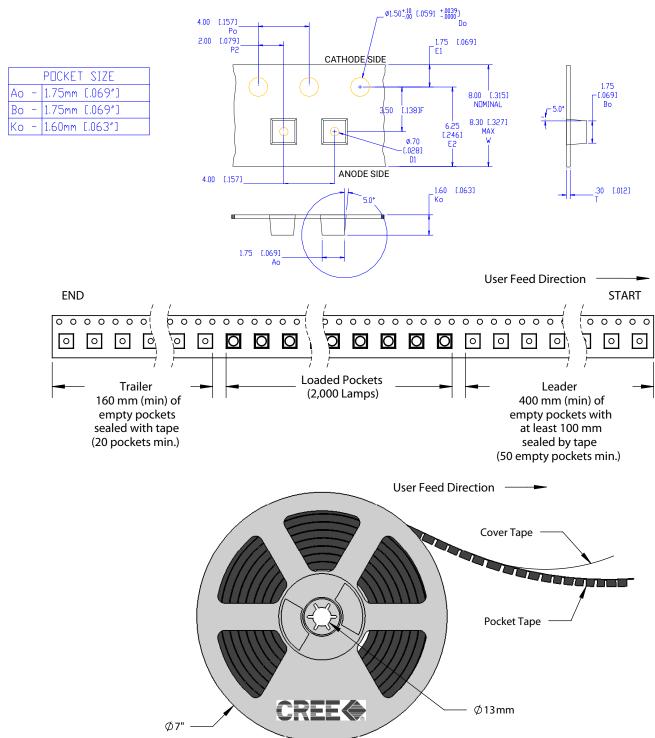


### **TAPE AND REEL**

All Cree carrier tapes conform to EIA-481D, Automated Component Handling Systems Standard.

Except as noted, all dimensions in mm [in].

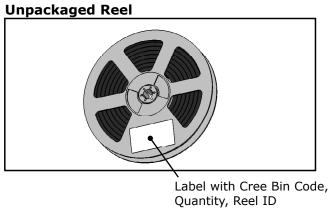
Measurement tolerances unless indicated otherwise: .xx = ±.25 mm, .xxx = . ± 125 mm

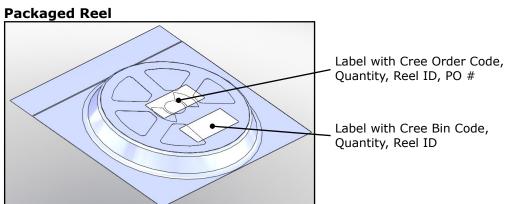


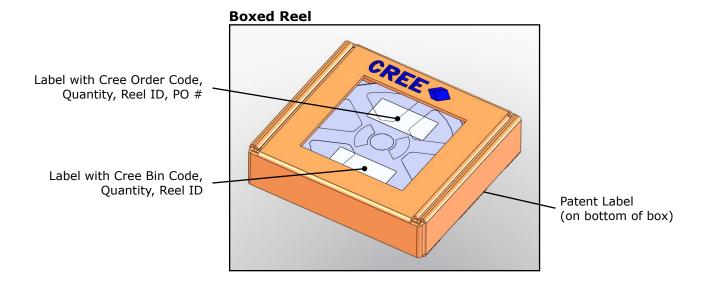


### **PACKAGING**

The diagrams below show the packaging and labels Cree uses to ship XLamp XQ-A LEDs. XLamp XQ-A LEDs are shipped in tape loaded on a reel. Each box contains only one reel in a moisture barrier bag.







# **X-ON Electronics**

Largest Supplier of Electrical and Electronic Components

Click to view similar products for High Power LEDs - Single Color category:

Click to view products by Cree manufacturer:

Other Similar products are found below:

L135-L567003500000 L1CU-VLT10000000000 GW PSLMS1.EC-GTHP-5J7K-1 LT G5AP-CZEX-36-1 LD G5AP-4M4N-35-1 XPEBRY-L1-0000-00802 SPHWH2L3D30ED4V0H3 XQEBLU-00-0000-000000202 LUWCQ7P-LPLR-5E8G-1-K KA-3535SELZ4S GH CSSPM1.24-4T2U-1 L1SP-DRD0002000000 L1SP-LME0002000000 LHUV-0395-A060 VLMTG1400-GS08 XPGDRY-L1-0000-00601-SB01 XTEARY-00-0000-000000L02 XQEGRN-H0-0000-00000901 XPEEPR-L1-0000-00801 XPERED-L1-0000-00801 XTEARY-00-0000-000000004 XPGDRY-L1-0000-00401 XQEEPR-00-0000-00000901 XQEEPR-00-0000-0000000A01 15335340AA350 XPCRDO-L1-R250-00701 XPEGRN-L1-0000-00F02 XRCRDO-L1-R250-00K03 15335339AA350 XQERDO-02-0000-000000701 XPEBGR-L1-0000-00E02 XPEROY-L1-R250-00B02 15335338AA350 XPEROY-L1-R250-00803 XPEBRY-L1-R250-00R01 XPCBLU-L1-R250-00Y01 XPEGRN-L1-0000-00F01 XPEBPA-L1-R250-00B01 XPERED-L1-R250-00802 XQEBLU-02-0000-00000305 XTEARY-00-0000-000000K03 XTEARY-02-0000-000000L03 XPEBBL-L1-R250-00302 VLMY71AAAC-GS08 XPCGRN-L1-R250-00601 LS H9PP-HYJY-1-1 XPEROY-L1-0000-00B02 XPERDO-L1-R250-00A03 XPCROY-L1-R250-00803 LST1-01G01-GRN1-00